

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>SU DONG HONG</td> <td>02/18/2008</td> </tr> <tr> <td>DONG SOO KIM</td> <td>02/18/2008</td> </tr> <tr> <td>TAE YUN JEONG</td> <td>02/18/2008</td> </tr> <tr> <td>SANG HWAN KIM</td> <td>02/18/2008</td> </tr> <tr> <td>JUNG HYUN OH</td> <td>02/18/2008</td> </tr> </tbody> </table>		Name	Execution Date	SU DONG HONG	02/18/2008	DONG SOO KIM	02/18/2008	TAE YUN JEONG	02/18/2008	SANG HWAN KIM	02/18/2008	JUNG HYUN OH	02/18/2008
Name	Execution Date												
SU DONG HONG	02/18/2008												
DONG SOO KIM	02/18/2008												
TAE YUN JEONG	02/18/2008												
SANG HWAN KIM	02/18/2008												
JUNG HYUN OH	02/18/2008												
RECEIVING PARTY DATA													
Name:	SSCP CO, LTD.												
Street Address:	#629-3, Seongkog-dong, Danwon-gu, Ansan-si												
City:	Kyungki-do												
State/Country:	KOREA, DEMOCRATIC PEOPLE'S REPUBLIC OF												
Postal Code:	425-833												
PROPERTY NUMBERS Total: 1													
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12088573</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12088573								
Property Type	Number												
Application Number:	12088573												
CORRESPONDENCE DATA													
Fax Number:	(212)278-1733												
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>													
Phone:	212-278-1359												
Email:	IPG@ANDERSONKILL.COM												
Correspondent Name:	DAVID A. EINHORN												
Address Line 1:	1251 AVENUE OF THE AMERICAS												
Address Line 2:	ANDERSON KILL & OLICK, P.C.												
Address Line 4:	NEW YORK, NEW YORK 10020-1182												
ATTORNEY DOCKET NUMBER:	DE1795												

CH \$40.00 12088573

NAME OF SUBMITTER:

EUGENE LIEBERSTEIN, REG. NO. 24,645

Total Attachments: 2

source=DE1795ASSIGNMENT#page1.tif

source=DE1795ASSIGNMENT#page2.tif

DE1795

JOINT

ASSIGNMENT

WHEREAS, WE, Su Dong HONG; Dong Soo KIM; Tae Yun JEONG; Sang Hwan KIM; and Jung Hyun OH, ASSIGNORS, citizens of Republic of Korea, residing at Ureukjugong Apt. 707-1401, #1146-11, Sanbon-dong, Gunpo-si, Gyeonggi-do 435-040, Republic of Korea; Ggotmoineulmaeul Sinan Apt. 241-1205, #883-6, Jeongja-2-dong, Jangan-gu, Suwon-si, Gyeonggi-do 440-302, Republic of Korea; Whiteville 205, #1172-2, Sa-dong, Sangrok-gu, Ansan-si, Gyeonggi-do 426-170, Republic of Korea; Geumgang Apt. 906-1501, Gungnae-dong, Gunpo-si, Gyeonggi-do 435-725, Republic of Korea; and Dongbu Starvilla 403, #1503-7, Jung-dong, Haeundae-gu, Pusan 612-010, Republic of Korea, respectively, are the inventors of the invention in

HIGH-SOLID UV-CURABLE COATING COMPOSITION

for which We have executed an application for a Patent of the United States

- which is executed on even date herewith or _____ (date)
- which is identified by Anderson Kill & Olick, P.C. docket no. DE1795
- which was filed on March 28, 2008, Serial No. 12/088,573

and WHEREAS, SSCP CO., LTD. of #629-3, Seongkog-dong, Danwon-gu, Ansan-si, Kyungki-do 425-833, Republic of Korea, ASSIGNEE, is desirous of obtaining the entire right, title and interest in, to and under the said invention and the said application:

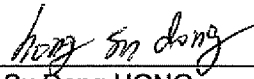
NOW, THEREFORE, in consideration of the sum of One Dollar (US\$1.00) to us in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, we, the said ASSIGNORS, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title and interest in, to and under the said invention, and the said United States application and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof, and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said United States application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewals and reissues thereof;

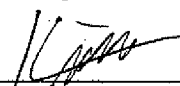
AND WE HEREBY authorize and request the Commissioner of Patents and Trademarks of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

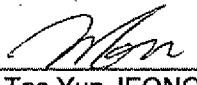
AND WE HEREBY covenant and agree that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.


AND WE HEREBY further covenant and agree that we will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries.

IN TESTIMONY WHEREOF, We hereunto set our hands and seals the day and year set opposite our respective signatures.

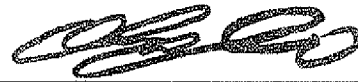
Date February 18, 2008  L.S.
 Su Dong HONG

Date February 18, 2008  L.S.
 Dong Soo KIM

Date February 18, 2008  L.S.
 Tae Yun JEONG

Date February 18, 2008  L.S.
 Sang Hwan KIM

Date February 18, 2008



Jung Hyun OH

L.S.